

**STEP-Z**

TE Internal #: 7-1761616-5

PCB Mount Header, Vertical, Board-to-Board, 296 Position, 1.3 mm
 [.051 in] Centerline, Partially Shrouded, Gold, Surface Mount -
 Solder Ball

[View on TE.com >](#)
[Connectors >](#) [PCB Connectors >](#) [PCB Headers & Receptacles](#)
PCB Connector Assembly Type: **PCB Mount Header**PCB Mount Orientation: **Vertical**Connector System: **Board-to-Board**Number of Positions: **296**Number of Rows: **2****Features****Product Type Features**

PCB Connector Assembly Type	PCB Mount Header
Connector System	Board-to-Board
Header Type	Partially Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Stackable	Yes
PCB Mount Orientation	Vertical
Number of Positions	296
Number of Rows	2
Board-to-Board Configuration	Parallel

Electrical Characteristics

Dielectric Withstanding Voltage (Max)	500 VAC
Insulation Resistance	18 MΩ
Operating Voltage	48 VAC

Body Features

Primary Product Color	Natural
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Contact Features



Contact Layout	Matrix
Mating Tab Width	1 mm[.04 in]
Mating Tab Thickness	.2 mm[.008 in]
Contact Shape & Form	Dual Beam, Single Beam, Square
PCB Contact Termination Area Plating Material	Tin-Silver
Contact Base Material	Copper Alloy
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.76 μm [29.9212 μin]
Contact Type	Tab
Contact Current Rating (Max)	1 A

Termination Features

Termination Method to Printed Circuit Board	Surface Mount - Solder Ball
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Mechanical Attachment

Mating Retention	With
Mating Alignment	Without
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount

Housing Features

Centerline (Pitch)	1.3 mm[.051 in]
Housing Material	Thermoplastic

Dimensions

Connector Height	25.95 mm[1.02 in]
Row-to-Row Spacing	2 mm[.079 in]
Stack Height	30 mm, 36 mm, 40 mm[1.575 in]
PCB Thickness (Recommended)	1.57 mm[.8 in]

Usage Conditions

Operating Temperature Range	0 – 100 °C[32 – 212 °F]
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Operation/Application

Assembly Process Feature	None
Circuit Application	Power & Signal

Industry Standards

UL Flammability Rating	UL 94V-0
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Packaging Features

Packaging Quantity	20
Packaging Type	Tray

Product Compliance

[For compliance documentation, visit the product page on TE.com>](#)

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Compatible Parts



TE Part # 5-1761617-5
STEP-Z RCPT 05MM 296P LF ST

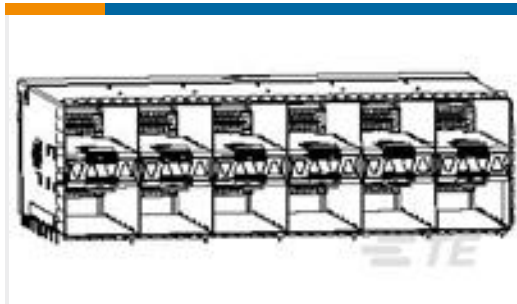


TE Part # 6-1761617-5
STEP-Z RCPT 15MM 296P LF ST

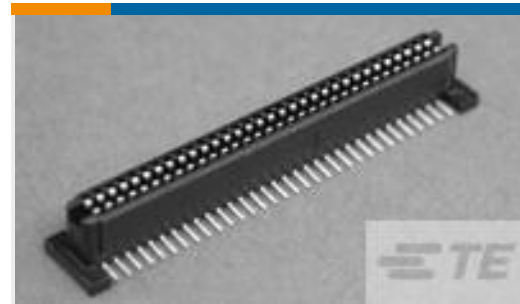


TE Part # 6-1761617-1
STEP-Z RCPT 11MM 296P LF ST

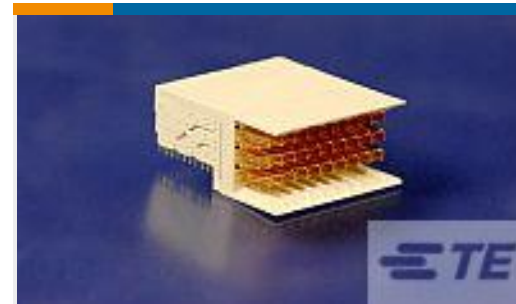
Customers Also Bought



TE Part #2198339-6
zSFP+ STACKED 2X6 RECEPTACLE
ASSEMBLY



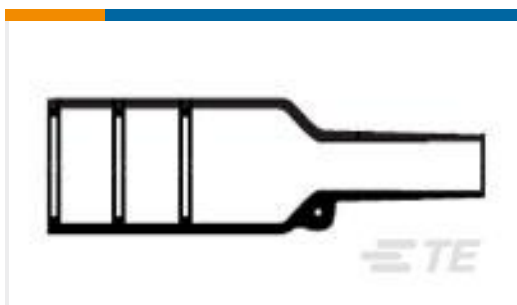
TE Part #5146893-1
1FHR,64,30A/S,S,C,S08,09,10



TE Part #6469183-1
HMZD 3PR RA HDR 60P ASSY LF



TE Part #9088924002
Single Thin Wall DR 25 TW Heat Shrink
Tubing 2:1 Shrink Ratio



TE Part #631516-000
202K121-100/180-0



TE Part #52189
TERMINAL,PIDG R 26-24 4



TE Part #2-2176264-9
RN 0805 1M0 0.1% 10PPM 1K RL



TE Part #2318579-1
RCPT CONN R/A SMT 76 POSN QSFP-
DD

Documents

Product Drawings

STEP-Z PLUG 25MM 296P LF ST

English

CAD Files

Customer View Model

[ENG_CVM_CVM_7-1761616-5_B.2d_dxf.zip](#)

English

3D PDF

3D

Customer View Model

[ENG_CVM_CVM_7-1761616-5_B.3d_igs.zip](#)

English

Customer View Model

[ENG_CVM_CVM_7-1761616-5_B.3d_stp.zip](#)

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

Datasheets & Catalog Pages

STEP-Z Interconnection System

English

Product Specifications

Product Specification

English

7-1761616-5

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Centerline, Partially Shrouded, Gold, Surface Mount - Solder Ball

